

## COLLECTION OF CIG-OSM/IN DECISIONS

<b>Standard:</b> EN 60730-1:1995	<b>Sub clause:</b> <b>Table 14.1</b>	<b>Sheet no.</b> OSM/IN 079  <b>Page 1(1)</b>
<b>Subject:</b> Maximum temperature permitted for .on Table 14.1 for materials used other than for wires	<b>Key words:</b> Maximum temperature	<b>Meeting no.</b> 9 <b>Item</b> 6.15 5.2
<p><b>Question:</b> Maximum temperature permitted for .on Table 14.1 for materials used other than for wires there is not a guidance for products as fibre glass or epoxy resin</p> <p><b>Decision:</b> For polyester the limit should be 135 °C For printed circuit board based in epoxy resin the limit should be 145 °C.</p> <p><b>Explanatory notes:</b> Interpretation Sheet modified on request of CLC/TC72</p>		